



HMC462LP5 / 462LP5E

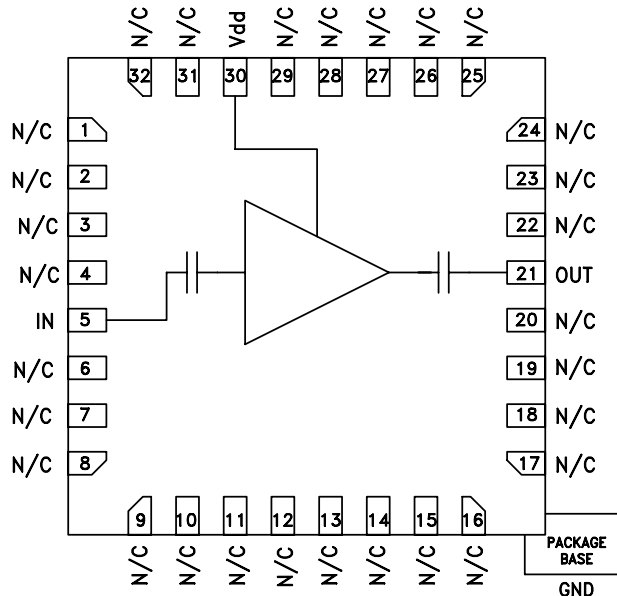
GaAs pHEMT MMIC LOW NOISE AMPLIFIER, 2 - 20 GHz

Typical Applications

The HMC462LP5 / HMC462LP5E Wideband LNA is ideal for:

- Telecom Infrastructure
- Microwave Radio & VSAT
- Military EW, ECM & C³I
- Test Instrumentation
- Fiber Optics

Functional Diagram



Features

Noise Figure: 2.5 dB @ 10 GHz

Gain: 13 dB

P1dB Output Power: +14.5 dBm @ 10 GHz

Self-Biased: +5V @ 66mA

50 Ohm Matched Input/Output

25 mm² Leadless SMT Package

General Description

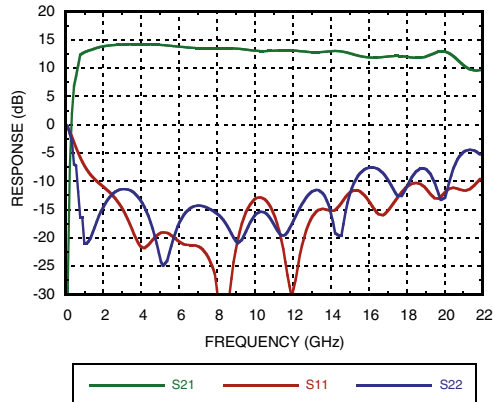
The HMC462LP5 & HMC462LP5E are GaAs MMIC pHEMT Low Noise Distributed Amplifiers in leadless 5x5 mm surface mount packages which operate between 2 and 20 GHz. The self-biased amplifier provides 13 dB of gain, 2.5 to 3.5 dB noise figure and +14.5 dBm of output power at 1 dB gain compression while requiring only 66 mA from a single +5V supply. Gain flatness is excellent from 6 - 18 GHz making the HMC462LP5 & HMC462LP5E ideal for EW, ECM RADAR and test equipment applications. The wideband amplifier I/Os are internally matched to 50 Ohms and are internally DC blocked.

Electrical Specifications, $T_A = +25^\circ\text{C}$, $V_{dd} = 5\text{V}$

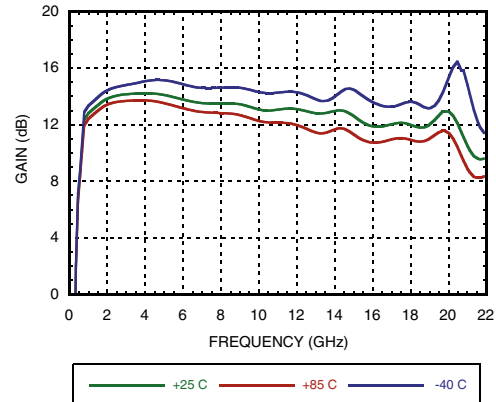
Parameter	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Units
Frequency Range	2 - 6			6 - 14			14 - 20			GHz
Gain	12	14		11	13		10	12		dB
Gain Flatness		± 0.5			± 0.5			± 0.5		dB
Gain Variation Over Temperature		0.015	0.025		0.02	0.03		0.03	0.04	dB/°C
Noise Figure		3.0	4.0		2.5	4.0		4.0	6.0	dB
Input Return Loss		15			13			11		dB
Output Return Loss		12			12			8		dB
Output Power for 1 dB Compression (P1dB)	12	15		11	14		9	12		dBm
Saturated Output Power (Psat)		17			16			15		dBm
Output Third Order Intercept (IP3)		26			25			22		dBm
Supply Current (I _{dd}) (V _{dd} = 5V)	41	66	84	41	66	84	41	66	84	mA

**GAAS PHEMT MMIC
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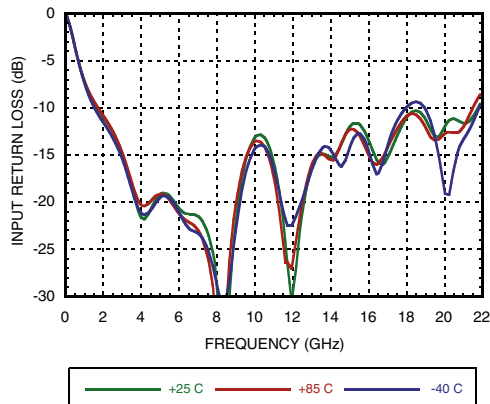
Gain & Return Loss



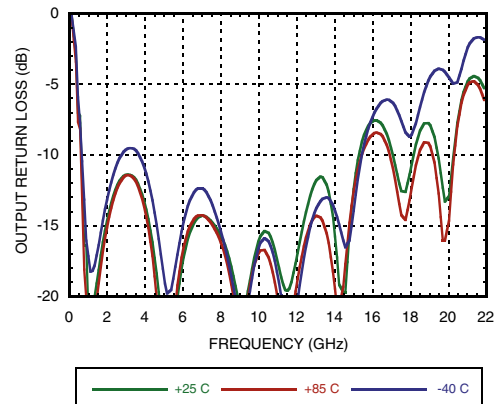
Gain vs. Temperature



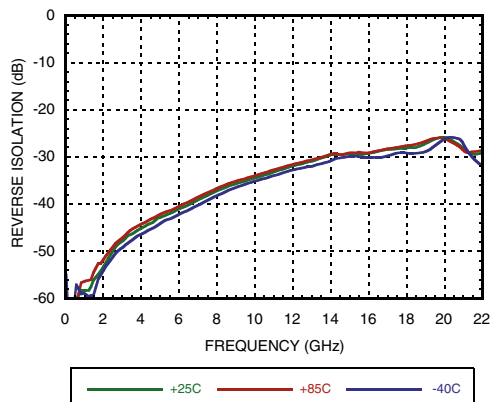
Input Return Loss vs. Temperature



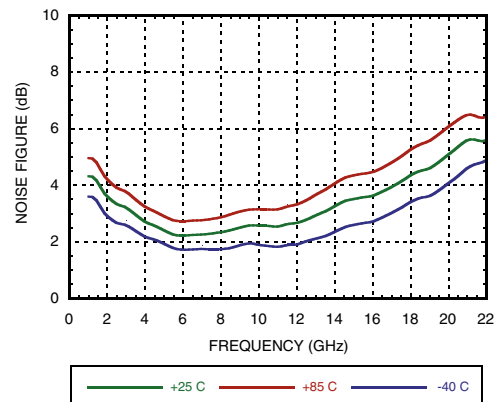
Output Return Loss vs. Temperature



Reverse Isolation vs. Temperature



Noise Figure vs. Temperature

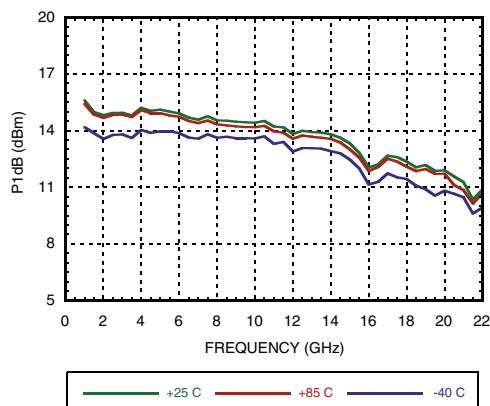




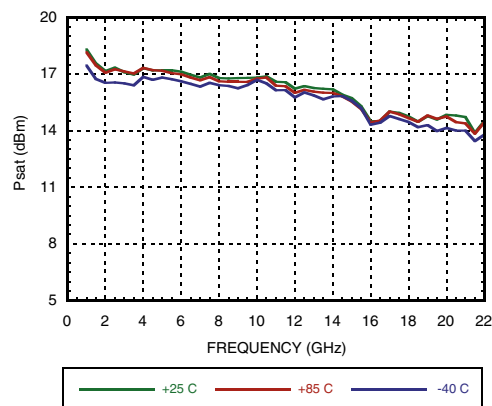
HMC462LP5 / 462LP5E

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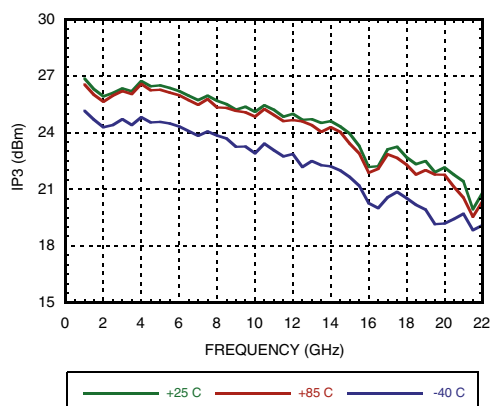
P1dB vs. Temperature



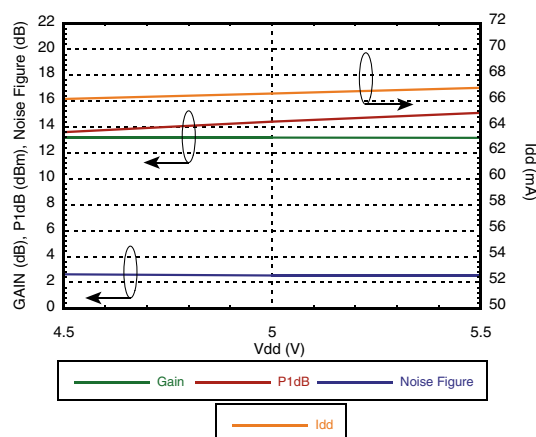
Psat vs. Temperature



Output IP3 vs. Temperature



Gain, Power, Noise Figure & Supply Current vs. Supply Voltage @ 10 GHz



Absolute Maximum Ratings

Drain Bias Voltage (Vdd)	+9 Vdc
RF Input Power (RFIN)(Vdd = +5 Vdc)	+18 dBm
Channel Temperature	150 °C
Continuous P _{diss} (T = 85 °C) (derate 50 mW/°C above 85 °C)	3.25 W
Thermal Resistance (channel to ground paddle)	52 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

Typical Supply Current vs. Vdd

Vdd (V)	Idd (mA)
+4.5	66
+5.0	67
+5.5	68
+7.5	71
+8.0	72
+8.5	73

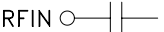

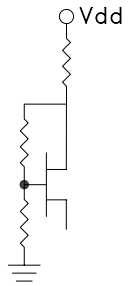



**ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS**



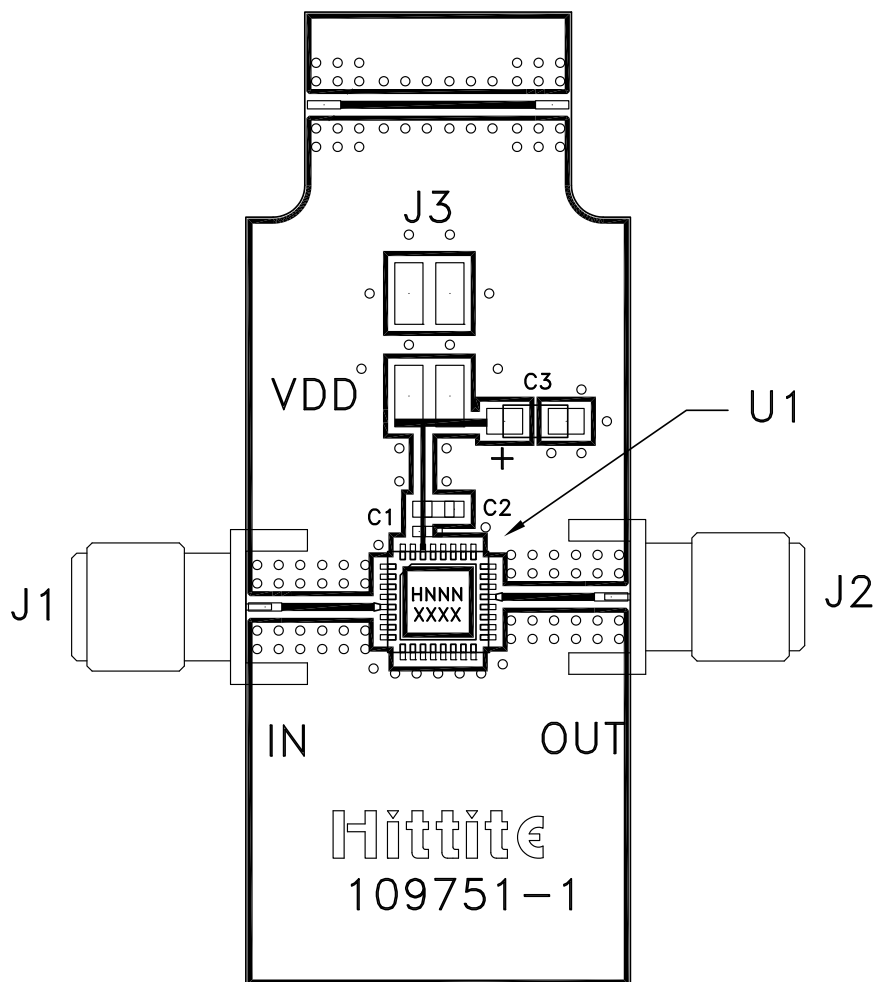
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Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1 - 4, 6 - 20, 22 - 29, 31, 32	N/C	No connection. These pins may be connected to RF ground. Performance will not be affected.	
5	RFIN	This pad is AC coupled and matched to 50 Ohms.	RFIN 
21	RFOUT	This pad is AC coupled and matched to 50 Ohms.	 RFOUT
30	Vdd	Power supply voltage for the amplifier. External bypass capacitors are required.	
Ground Paddle	GND	Ground paddle must be connected to RF/DC ground.	

**GAAS PHEMT MMIC
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Evaluation PCB



List of Materials for Evaluation PCB 108338 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	2 mm Molex Header
C1	100 pF Capacitor, 0402 Pkg.
C2	1000 pF Capacitor, 0603 Pkg.
C3	4.7 μF Capacitor, Tantalum
U1	HMC462LP5 / HMC462LP5E
PCB [2]	109751 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and package bottom should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

Mouser Electronics

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[108338-HMC462LP5](#)